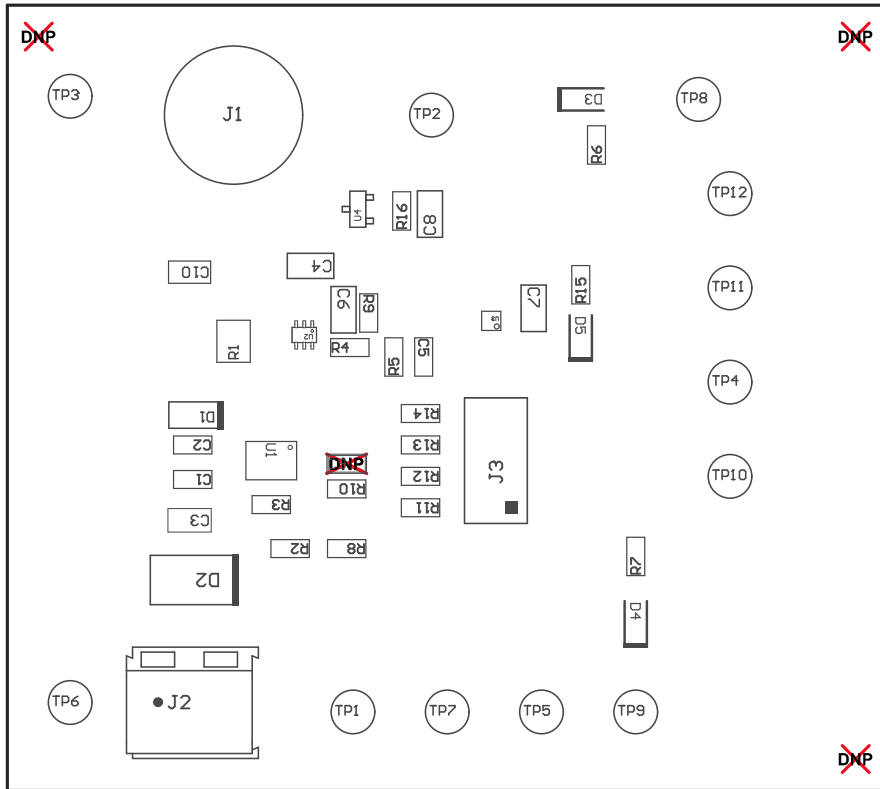


Z22 ■ These assemblies are ESD sensitive, ESD precautions shall be observed.

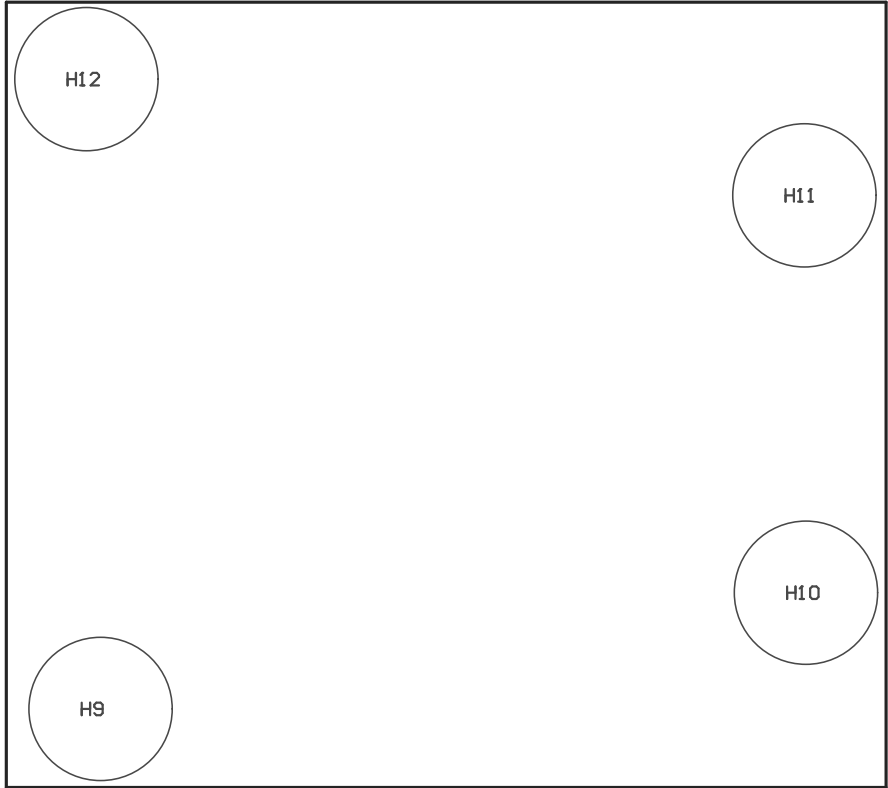
Z23 ■ These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

Z24 ■ These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: TIDA-01514	REV: E1	SUN REV: Not In VersionControl
	TID #: TIDA-01514		
PLOT NAME = Top Assembly Drawing	GENERATED : 9/27/2017 12:33:21 PM	TEXAS INSTRUMENTS	



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDA-01514	REV: E1	SVN REV: Not In VersionControl
	TID #: TIDA-01514		
PLOT NAME = Bottom Assembly Drawing	GENERATED : 9/27/2017 12:33:22 PM	TEXAS INSTRUMENTS	

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